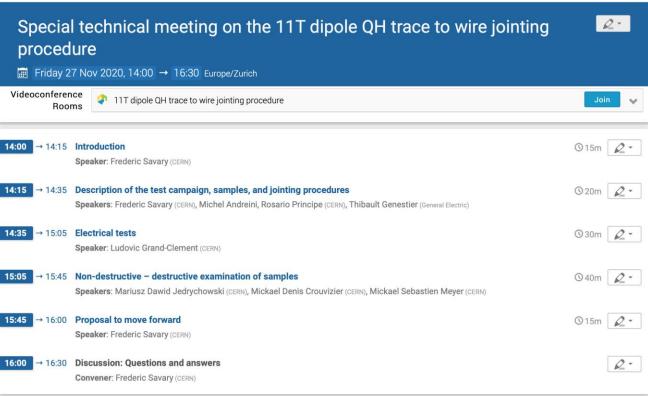


Special Technical Meeting on the 11T Dipole QH-Trace to Wire Jointing Introduction

F. Savary



Agenda of today's meeting



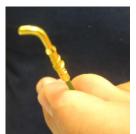




Why this meeting?

- There have been QH failures during the cold tests of two 11T dipole magnets:
 - One in the magnet S3 (LMBHA-002) tested in Jan./Feb. 2020
 - Another one in the magnet S4 (LMBHB-003) tested in Sept./Oct. 2020
- Till then, none of the 40 connections of the coils equipped with impregnated QHs (10 series coils) had shown any issue
- Whereas, 2 out of 32 connections of the coils equipped with external QHs (8 series coils) have failed in open loop
- As to S3, reflectometry, and later on visual inspection of the coil, have pointed to the QH-trace to wire jointing, as shown on the picture below
- S4 is not yet dismounted but reflectometry is pointing to the same location







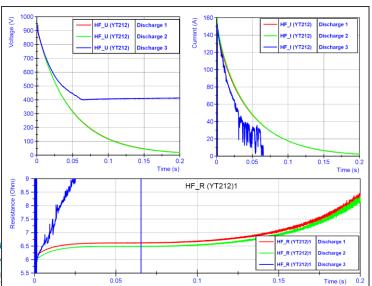




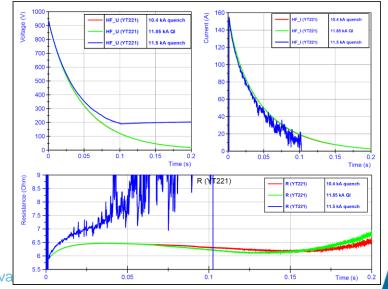


QH-trace to wire jointing issue – Facts

- Case of the magnet S3, coil C14, D2-Lo
 - At RT, in production, 4 discharge tests are made, 1 after collaring, 3 during CM construction (400 V, 80 A)
 - Failure at 3rd QH firing during reception tests at cold prior to powering (900 V, 150 A)
 - Circuit YT-212
 - No sign of degradation during the first 2 discharges
 - NCR EDMS 2311125



- Case of the magnet S4, coil C17, D2-Up
 - At RT, in production, 4 discharge tests are made, 1 after collaring, 3 during CM construction (400 V, 80 A)
 - Failure at 12th QH firing at cold
 - Circuit YT-221
 - No sign of degradation during the previous discharges
 - NCR EDMS <u>2423242</u>





F. Sava

11T dipole magnets inventory

Magnet ID	Impregnated QHs	External QHs	QH Failure - NCR
LMBHB001 – P1 – Proto	X		None
LMBHP001 – H1 – Hybrid	X		None
LMBH B 002 – S1	X		None
LMBH A 001 – S2	X		None
LMBH A 002 – S3		X	1 circuit in C14
LMBH B 003 - S4		X	1 circuit in C17
LMBH A 003 – S5		X	Not tested at cold
LMBH B 004 – S6		X	Not yet fabricated
LMBH A 004 – S7		X	Not yet fabricated





Why this meeting?

- To review the work that has been done
 - To characterize the electrical integrity of the soldered joints (endurance, robustness) of the baseline concept, and of alternative concepts
 - 2. To assess the quality of the soldered joints
 - 3. To determine the root cause of the non-conformity
- To review, and hopefully endorse the proposed solution





2020.11.27



Thank you for your attention! Questions?

